



IRF350-353
N-channel Power MOSFETs,
15 A, 350 V/400 V

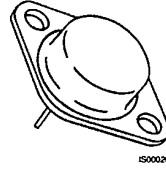
T-39-13

Power And Discrete Division

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltage, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.

TO-204AA



- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $V_{DS(on)}$, SOA and $V_{GS(th)}$ Specified at Elevated Temperature
- Rugged

IRF350
 IRF351
 IRF352
 IRF353

2

Maximum Ratings

Symbol	Characteristic	Rating IRF350/352	Rating IRF351/353	Unit
V_{DSS}	Drain to Source Voltage	400	350	V
V_{DGR}	Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$	400	350	V
V_{GS}	Gate to Source Voltage	± 20	± 20	V
T_J, T_{stg}	Operating Junction and Storage Temperatures	-55 to +150	-55 to +150	$^{\circ}\text{C}$
T_L	Maximum Lead Temperature for Soldering Purposes, 1/8" From Case for 5 s	275	275	$^{\circ}\text{C}$

Maximum On-State Characteristics

		IRF350/351	IRF352/353	
$R_{DS(on)}$	Static Drain-to-Source On Resistance	0.3	0.4	Ω
I_D	Drain Current			A
	Continuous	15	13	
	Pulsed	60	52	

Maximum Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.83	0.83	$^{\circ}\text{C}/\text{W}$
P_D	Total Power Dissipation at $T_C = 25^{\circ}\text{C}$	150	150	W

Notes
 For information concerning connection diagram and package outline, refer to Section 7.

IRF350-353

T-39-13

Electrical Characteristics ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	Test Conditions
Off Characteristics					
$V_{(BR)DSS}$	Drain Source Breakdown Voltage ¹			V	$V_{GS} = 0\text{ V}$, $I_D = 250\ \mu\text{A}$
	IRF350/352	400			
	IRF351/353	350			
I_{DSS}	Zero Gate Voltage Drain Current		250	μA	$V_{DS} = \text{Rated } V_{DSS}$, $V_{GS} = 0\text{ V}$
			1000	μA	$V_{DS} = 0.8 \times \text{Rated } V_{DSS}$, $V_{GS} = 0\text{ V}$, $T_C = 125^\circ\text{C}$
I_{GSS}	Gate-Body Leakage Current		± 100	nA	$V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{ V}$
On Characteristics					
$V_{GS(th)}$	Gate Threshold Voltage	2.0	4.0	V	$I_D = 250\ \mu\text{A}$, $V_{DS} = V_{GS}$
$R_{DS(on)}$	Static Drain-Source On-Resistance ²			Ω	$V_{GS} = 10\text{ V}$, $I_D = 8.0\text{ A}$
	IRF350/351		0.3		
	IRF352/353		0.4		
g_{fs}	Forward Transconductance	8.0		S (Ω)	$V_{DS} = 10\text{ V}$, $I_D = 8.0\text{ A}$
Dynamic Characteristics					
C_{iss}	Input Capacitance		3000	pF	$V_{DS} = 25\text{ V}$, $V_{GS} = 0\text{ V}$ $f = 1.0\text{ MHz}$
C_{oss}	Output Capacitance		600	pF	
C_{rss}	Reverse Transfer Capacitance		200	pF	
Switching Characteristics ($T_C = 25^\circ\text{C}$, Figures 9, 10)					
$t_{d(on)}$	Turn-On Delay Time		35	ns	$V_{DD} = 180\text{ V}$, $I_D = 8.0\text{ A}$ $V_{GS} = 10\text{ V}$, $R_{GEN} = 4.7\ \Omega$ $R_{GS} = 4.7\ \Omega$
t_r	Rise Time		65	ns	
$t_{d(off)}$	Turn-Off Delay Time		150	ns	
t_f	Fall Time		75	ns	
Q_g	Total Gate Charge		120	nC	$V_{GS} = 10\text{ V}$, $I_D = 16\text{ A}$ $V_{DD} = 400\text{ V}$
Symbol Characteristic Typ Max Unit Test Conditions					
Source-Drain Diode Characteristics					
V_{SD}	Diode Forward Voltage			V	$I_S = 15\text{ A}$; $V_{GS} = 0\text{ V}$
	IRF350/351		1.6	V	
	IRF352/353		1.5	V	$I_S = 13\text{ A}$; $V_{GS} = 0\text{ V}$
t_{rr}	Reverse Recovery Time	600		ns	$I_S = 15\text{ A}$; $di_S/dt = 100\text{ A}/\mu\text{S}$

Notes

- $T_J = +25^\circ\text{C}$ to $+150^\circ\text{C}$
- Pulse test: Pulse width $\leq 80\ \mu\text{s}$, Duty cycle $\leq 1\%$

IRF350-353

T-39-13

Typical Performance Curves

Figure 1 Output Characteristics

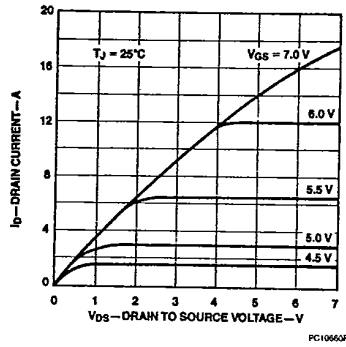


Figure 2 Static Drain to Source On Resistance vs Drain Current

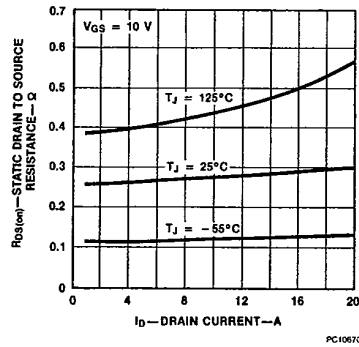


Figure 3 Transfer Characteristics

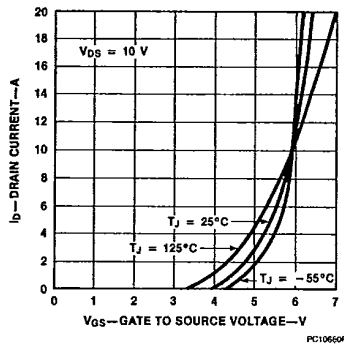


Figure 4 Temperature Variation of Gate to Source Threshold Voltage

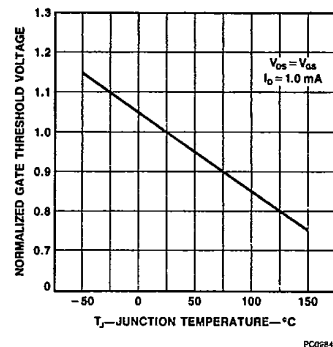


Figure 5 Capacitance vs Drain to Source Voltage

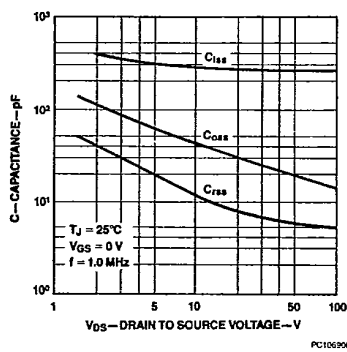
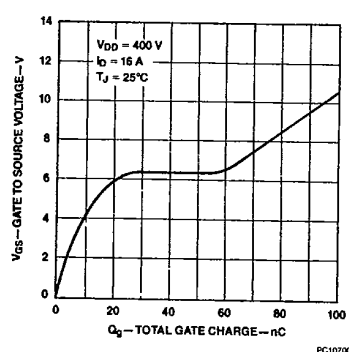


Figure 6 Gate to Source Voltage vs Total Gate Charge



IRF350-353

T-39-13

Typical Performance Curves (Cont.)

Figure 7 Forward Biased Safe Operating Area

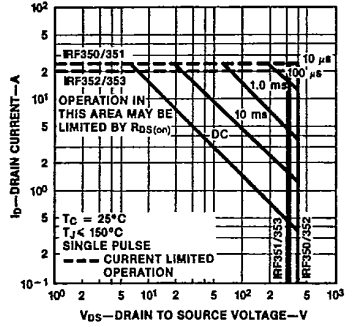
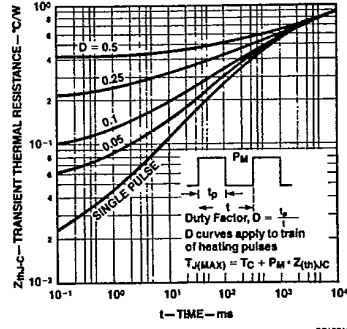


Figure 8 Transient Thermal Resistance vs Time



Typical Electrical Characteristics

Figure 9 Switching Test Circuit

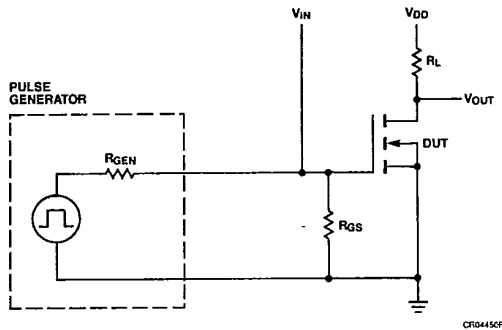
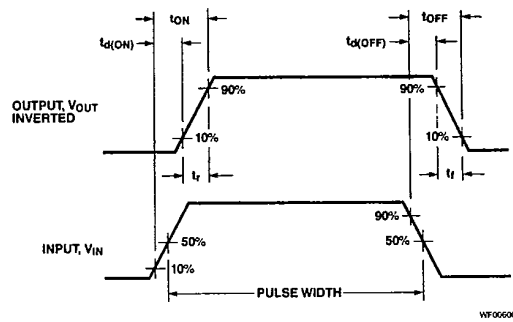


Figure 10 Switching Waveforms



This datasheet has been downloaded from:

www.DatasheetCatalog.com

Datasheets for electronic components.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.